

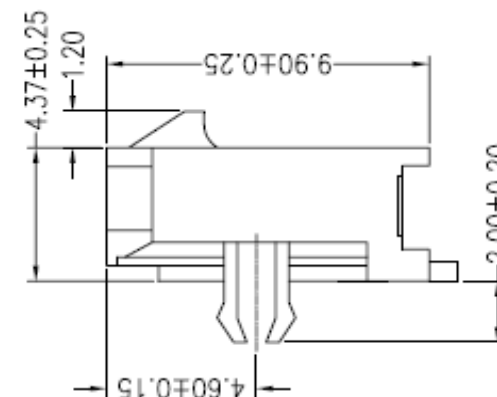
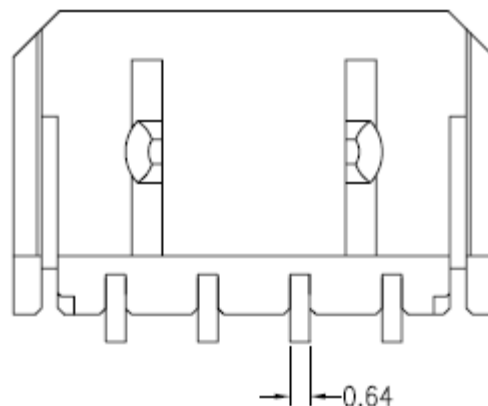
EDCON-COMPONENTS



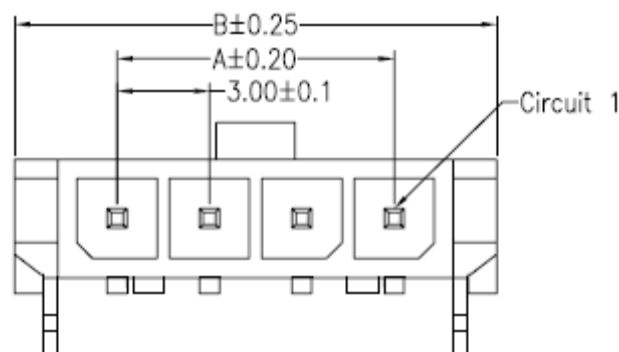
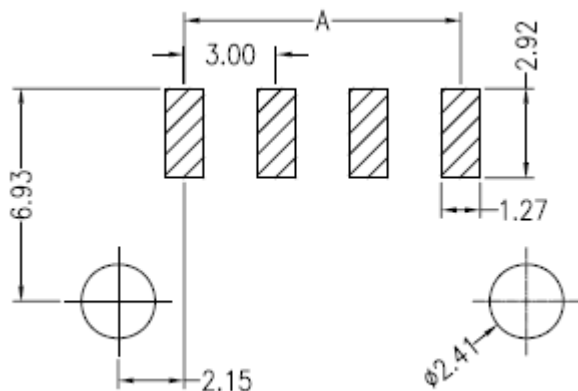
Specifications

Voltage Rating:	250VAC/DC
Current Rating	5,0A
Operating Temperature	. -25°C ~ +85°C
Contact Resistance	10m Ohm max.
Withstanding Voltage	1500VAC/Minute
Insulation Resistance	1000M Ohm min.
Contact Material:	Brass
Contact Plating :	AU or Sn over Ni.
Insulator Material:	High Temperature Plastic UL94V-0

Drawing (dimensions all into mm)



Terminal Assembly Drawing



Wafer Serie T68Qxxx Pitch
3,00mm

Part No.: **T68Q021**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 4	

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Dimension Informations about Wafer

Pos.	Dimension (mm)					
	A	B	C	D	E	F
2	3,00	9,65				
3	6,00	12,65				
4	9,00	15,54				
5	12,00	18,65				
6	15,00	21,65				
7	18,00	24,65				
8	21,00	27,65				
9	24,00	30,65				
10	27,00	33,65				
11	30,00	36,65				
12	33,00	39,65				

Pos.	Dimension (mm)					
	A	B	C	D	E	F

Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q021
Customer:

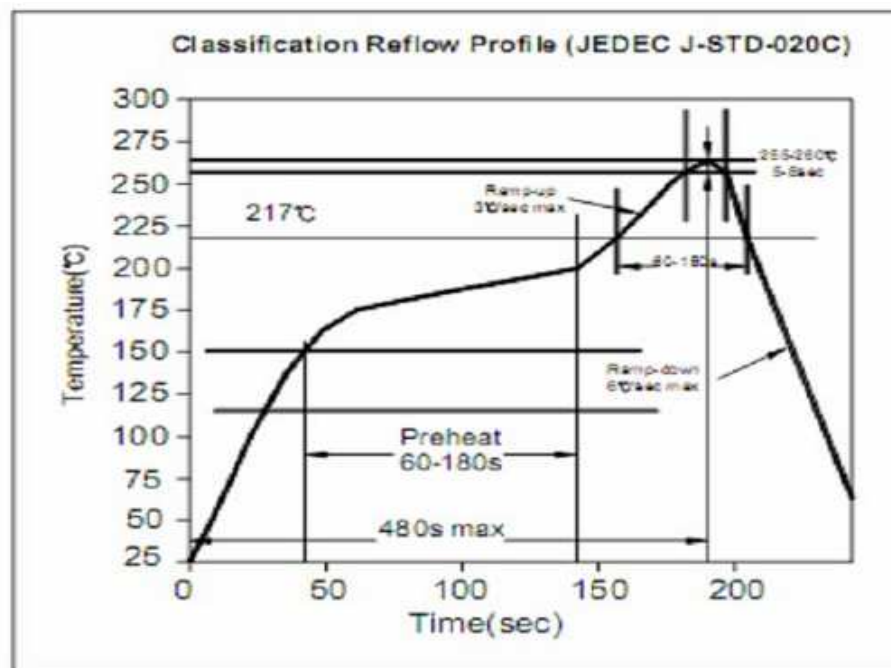
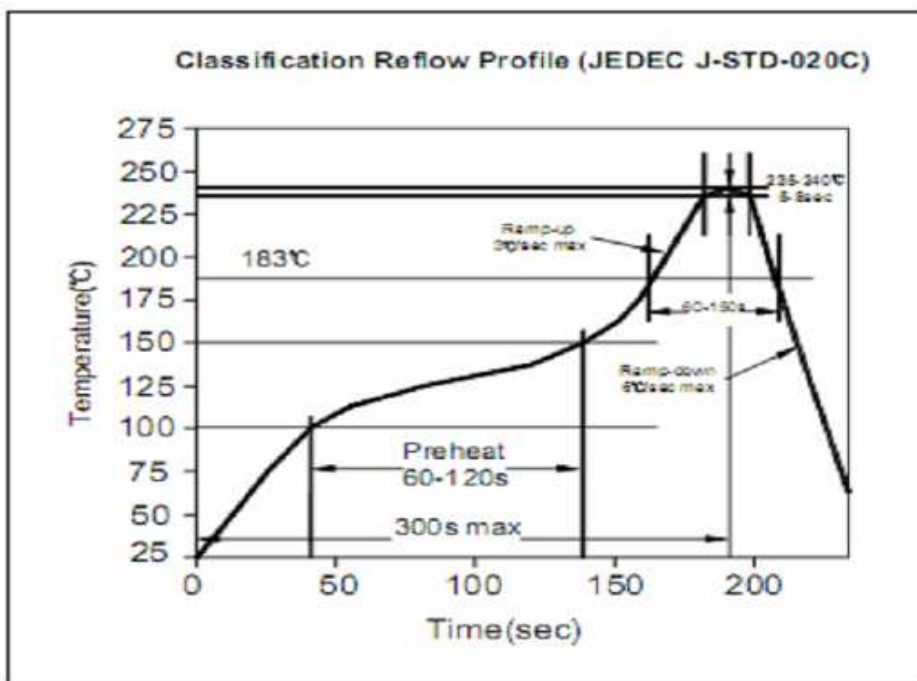
DRW: Jason	CHKD: Wilson	MATL: Wilson	TOLERANCE: Mason	DATE: 02.04.2009
APPD: Schumi	FINISH: Jamy	Sheet No.:	2 from 4	



Soldering Profile

Lead Solder

Lead Free Solder



Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q021
Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	3 from 4	

EDCON-COMPONENTS



Ordering Informations

Serie	Number of	Contact	Packing						
T68Q021	02	T	BU						

xx = Pos.	T= Tin Plated (Standard)	BU= Bulk (Standard)							
		TY= Tray Packing							
	G= Gold Flash Plated	TU= Tube Packing							

Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q021
Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	4 from 4	